



# PESD3V3Y1BSF

Extremely low capacitance bidirectional ESD protection diode

7 June 2018

Product data sheet

## 1. General description

Extremely low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode, part of the TrEOS protection family. This device is housed in a DSN0603-2 (SOD962) leadless ultra small Surface-Mounted Device (SMD) package designed to protect one signal line from the damage caused by ESD and other transients.

## 2. Features and benefits

- Bidirectional ESD protection of one line
- Extremely low trigger-voltage  $V_{t1}$  of 7 V TLP
- Extremely low diode capacitance  $C_d = 0.24$  pF
- Extremely low clamping voltage to protect sensitive I/Os
- Extremely low-inductance protection path to ground
- ESD protection up to  $\pm 15$  kV according to IEC 61000-4-2
- Ultra small SMD package

## 3. Applications

- USB 3.2, HDMI2, and Universal Flash Storage (UFS) data lines
- Cellular handsets and accessories
- Portable electronics
- Communication systems
- Computers and peripherals

## 4. Quick reference data


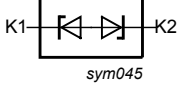
Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{RWM}$	reverse standoff voltage		-	-	3.3	V
$C_d$	diode capacitance	$f = 1$ MHz; $V_R = 0$ V; $T_{amb} = 25$ °C	[1]	0.24	0.29	pF

[1] Guaranteed by design.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 <p>Transparent top view <b>DSN0603-2 (SOD962)</b></p>	 <p><i>sym045</i></p>
2	K2	cathode (diode 2)		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PESD3V3Y1BSF	DSN0603-2	silicon, leadless ultra small package; 2 terminals; 0.4 mm pitch; 0.6 x 0.3 x 0.3 mm body	SOD962

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PESD3V3Y1BSF	C5

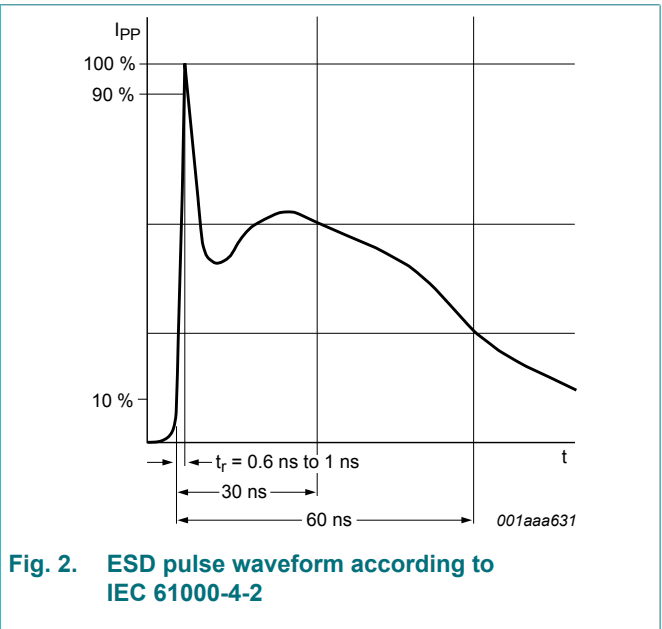
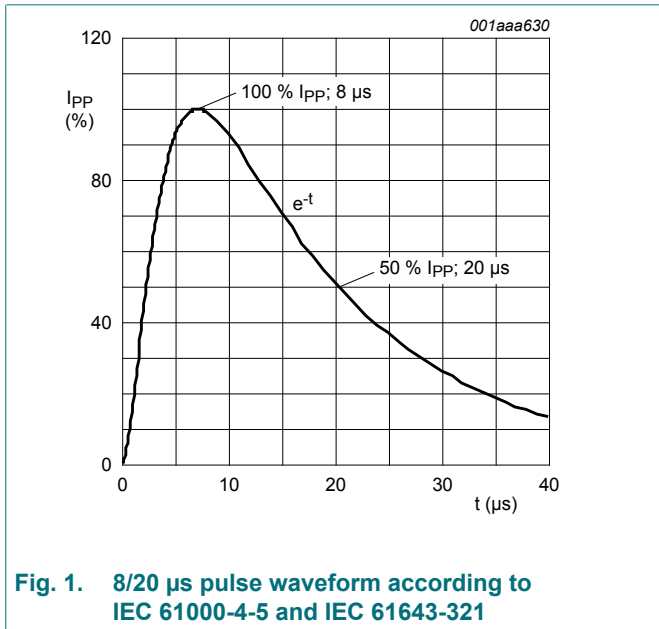
## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RWM}$	reverse standoff voltage			-	3.3	V
$T_{amb}$	ambient temperature			-40	125	°C
$T_{stg}$	storage temperature			-65	150	°C
<b>ESD maximum ratings</b>						
$V_{ESD}$	electrostatic discharge voltage	IEC 61000-4-2; contact discharge	[1]	-15	15	kV
		IEC 61000-4-2; air discharge	[1]	-15	15	kV

[1] Device stressed with ten non-repetitive ESD pulses.

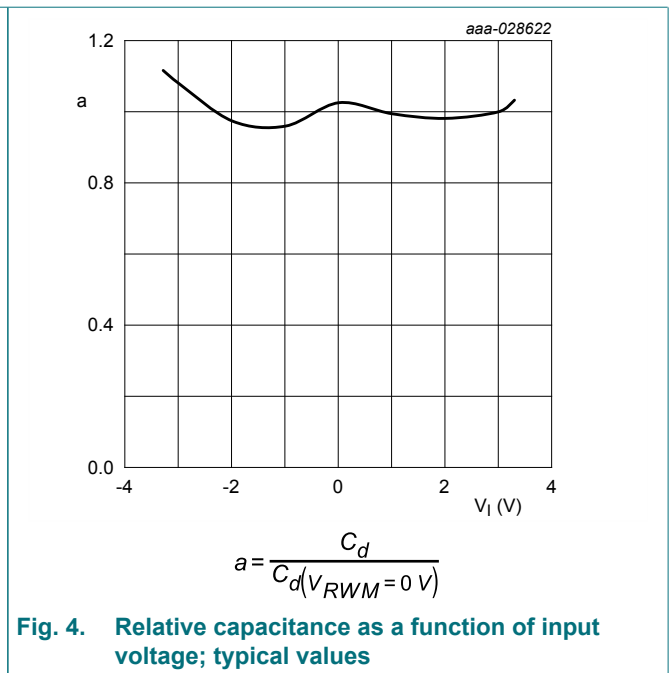
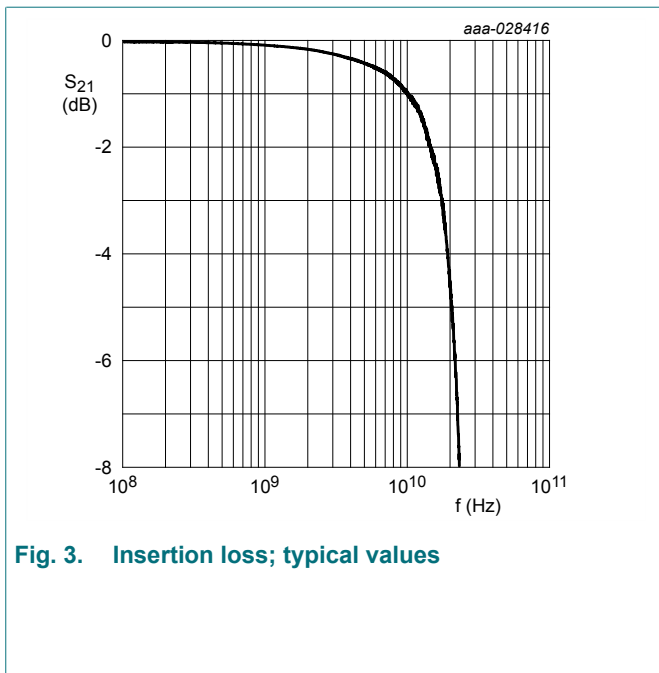


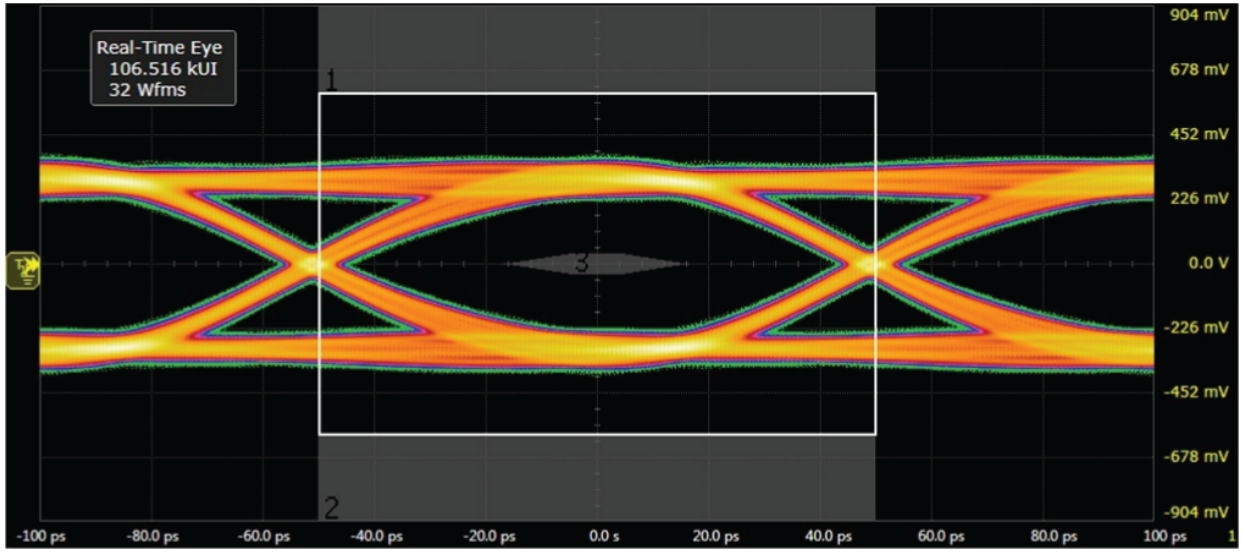
## 9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V <sub>BR</sub>	breakdown voltage	I <sub>R</sub> = 1 mA; T <sub>amb</sub> = 25 °C		4.2	6.2	8	V
I <sub>RM</sub>	reverse leakage current	V <sub>RWM</sub> = 3.3 V; T <sub>amb</sub> = 25 °C		-	1	50	nA
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V; T <sub>amb</sub> = 25 °C	[1]	-	0.24	0.29	pF
V <sub>CL</sub>	clamping voltage	I <sub>PPM</sub> = 4 A; T <sub>amb</sub> = 25 °C	[2]	-	3.7	-	V
R <sub>dyn</sub>	dynamic resistance	I <sub>R</sub> = 10 A; T <sub>amb</sub> = 25 °C	[3]	-	0.25	-	Ω
		I <sub>R</sub> = -10 A; T <sub>amb</sub> = 25 °C	[3]	-	0.25	-	Ω
f <sub>-3dB</sub>	-3 dB cut-off frequency	T <sub>amb</sub> = 25 °C; normalized to attenuation at 1 MHz		-	19.6	-	GHz

- [1] Guaranteed by design.
- [2] Device stressed with 8/20 μs exponential decay waveform according to IEC 61000-4-5.
- [3] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.1-2008.

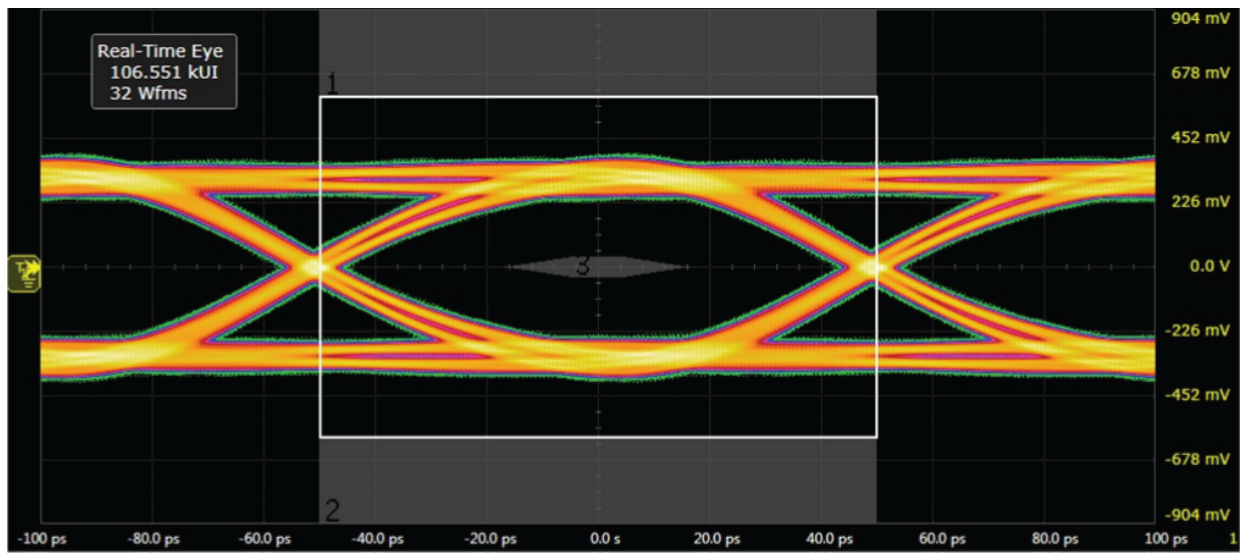




aaa-028417

Data rate: 10 Gbit/s

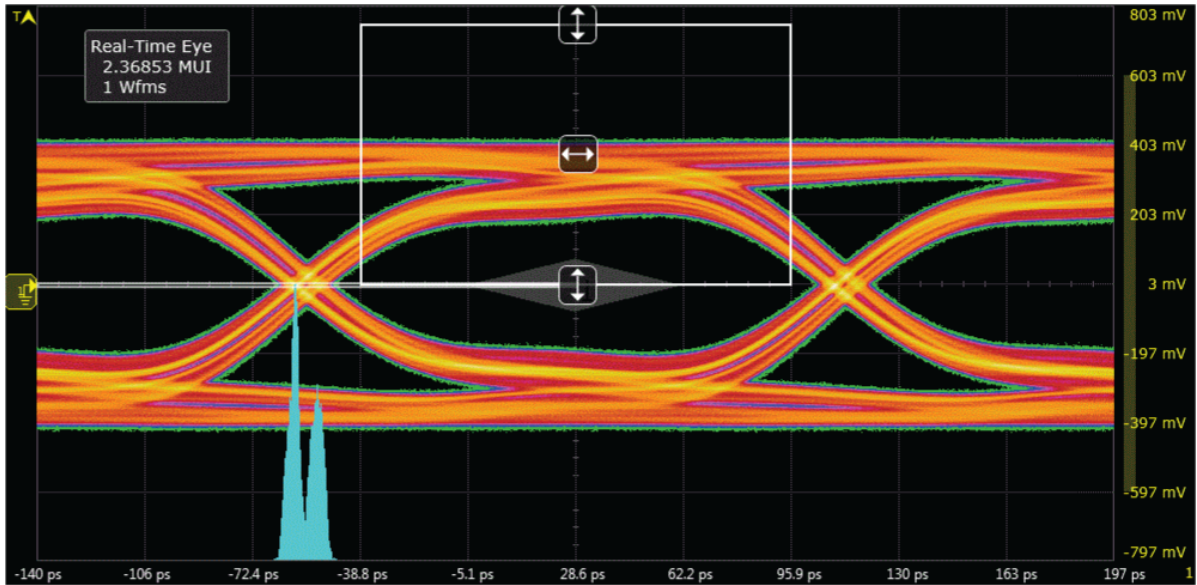
Fig. 5. USB 3.2 eye diagram, PCB with device; typical values



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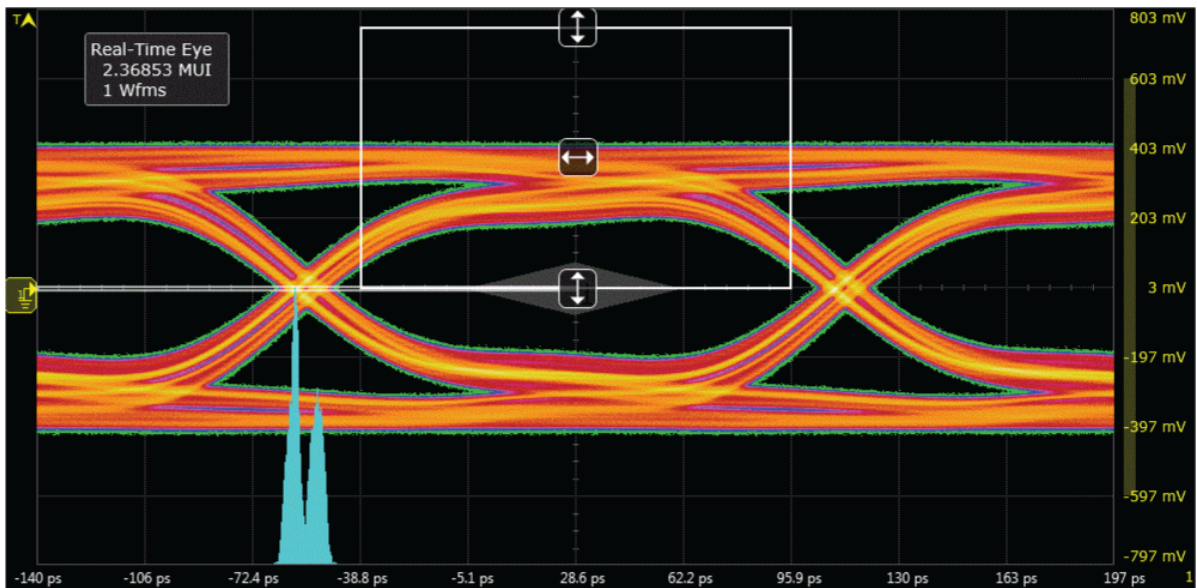
Data rate: 10 Gbit/s

Fig. 6. USB 3.2 eye diagram, PCB without device; typical values



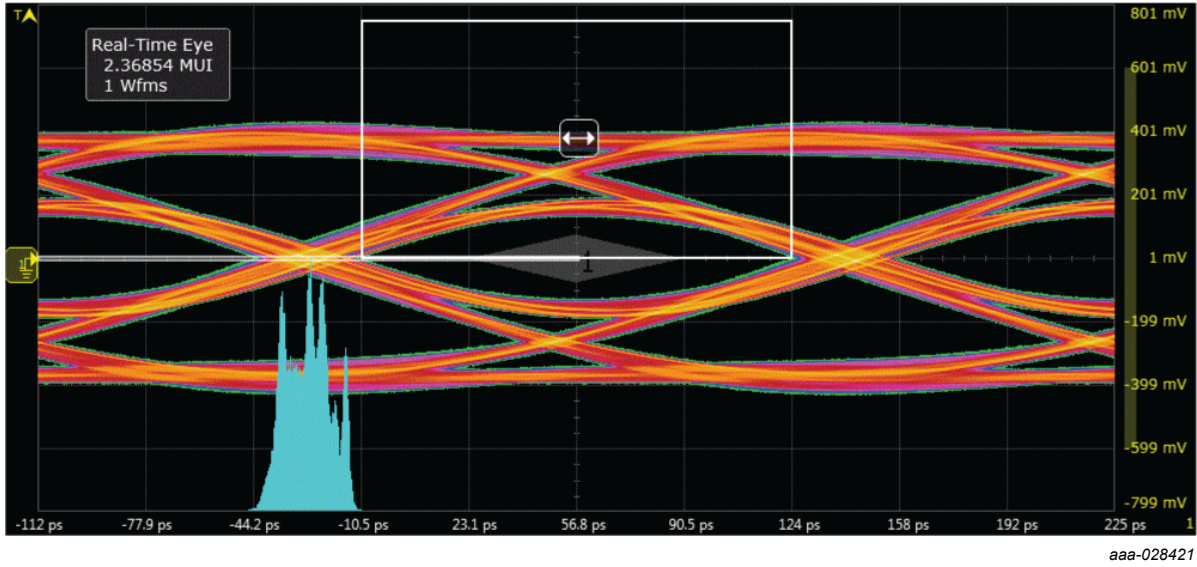
1080p  
Data rate: 6 Gbit/s

Fig. 7. HDMI TP1 eye diagram, PCB with device; typical values



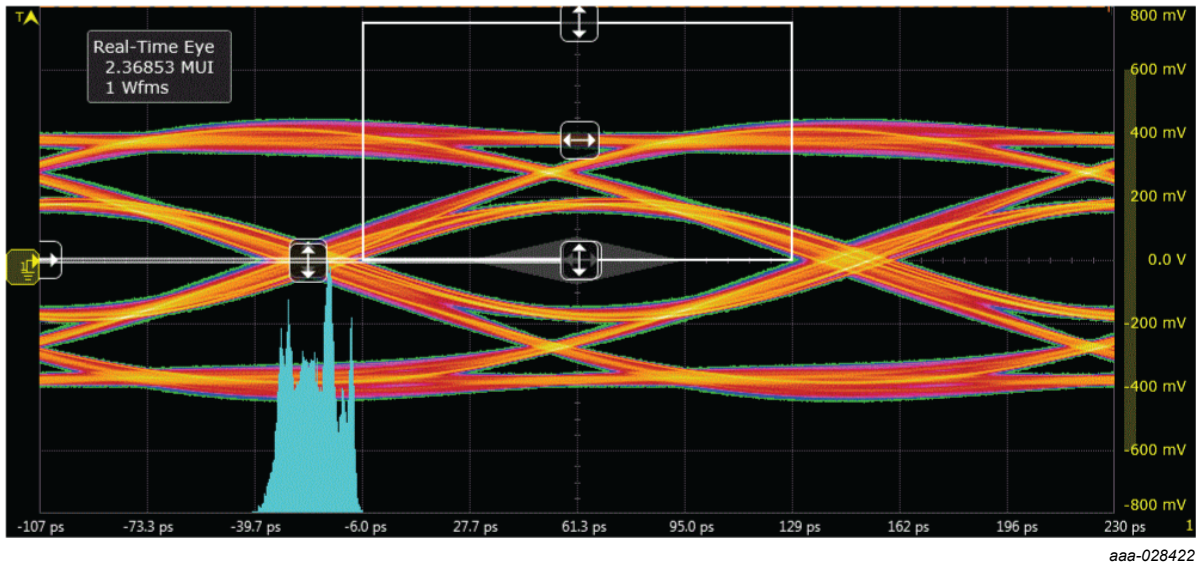
1080p  
Data rate: 6 Gbit/s

Fig. 8. HDMI TP1 eye diagram, PCB without device; typical values



1080p  
Data rate: 6 Gbit/s

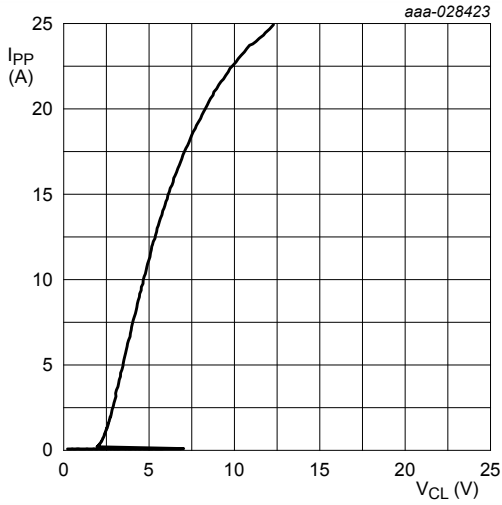
Fig. 9. HDMI TP2 eye diagram, PCB with device; typical values



1080p  
Data rate: 6 Gbit/s

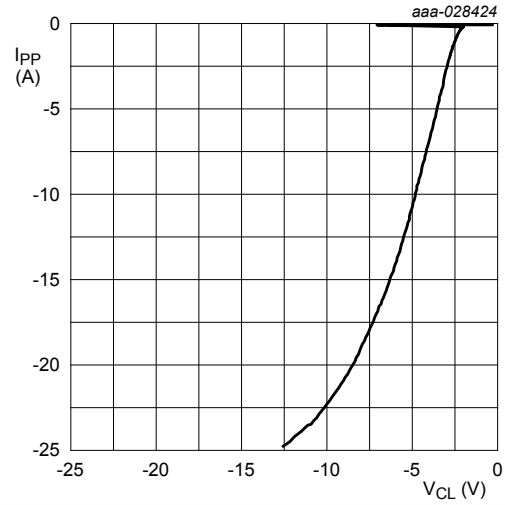
Fig. 10. HDMI TP2 eye diagram, PCB without device; typical values





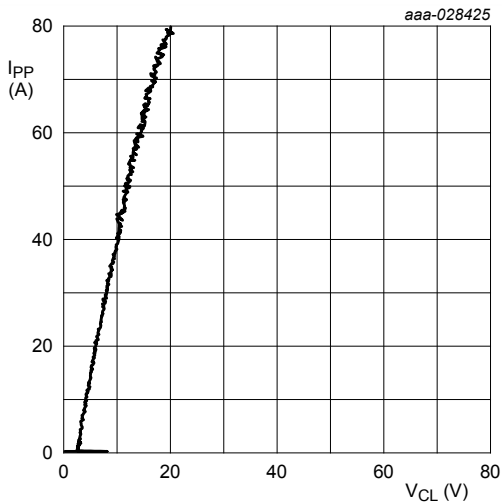
$t_r = 1 \text{ ns}$   
 $t_p = 100 \text{ ns}$ ; Transmission Line Pulse (TLP)

**Fig. 11. Dynamic resistance with positive clamping; typical values**



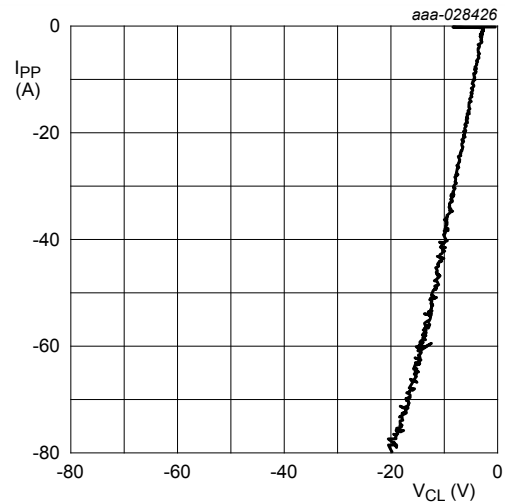
$t_r = 1 \text{ ns}$   
 $t_p = 100 \text{ ns}$ ; Transmission Line Pulse (TLP)

**Fig. 12. Dynamic resistance with negative clamping; typical values**



$t_r = 600 \text{ ps}$   
 $t_p = 5 \text{ ns}$ ; Very-Fast Transmission Line Pulse (VF-TLP)

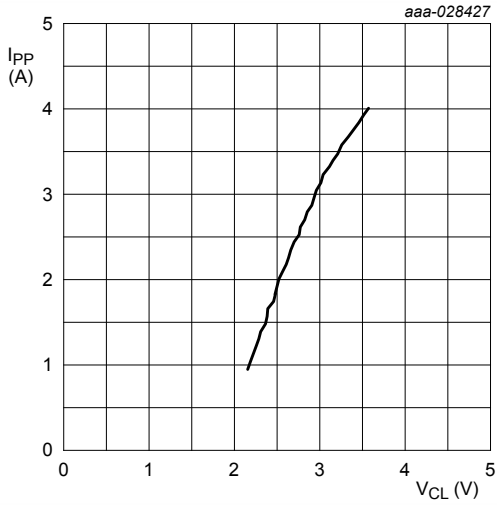
**Fig. 13. Dynamic resistance with positive clamping; typical values**



$t_r = 600 \text{ ps}$   
 $t_p = 5 \text{ ns}$ ; Very Fast Transmission Line Pulse (VF-TLP)

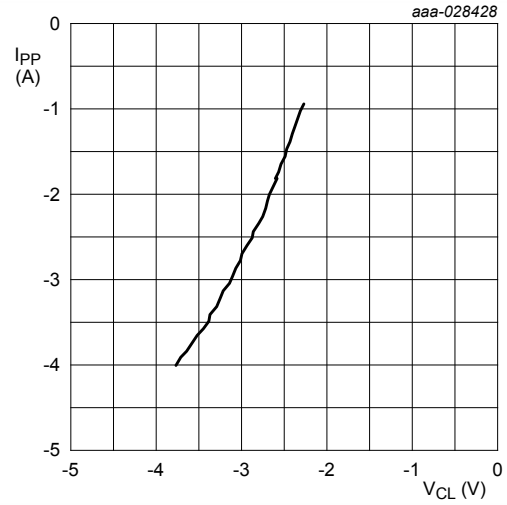
**Fig. 14. Dynamic resistance with negative clamping; typical values**





IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; positive pulse

**Fig. 15. Dynamic resistance with positive clamping; typical values**



IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; negative pulse

**Fig. 16. Dynamic resistance with negative clamping; typical values**

## 10. Application information

The device is designed for the protection of one bidirectional data line from surge pulses and ESD damage. The device is suitable on lines where the signal polarities are both positive and negative with respect to ground.

The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

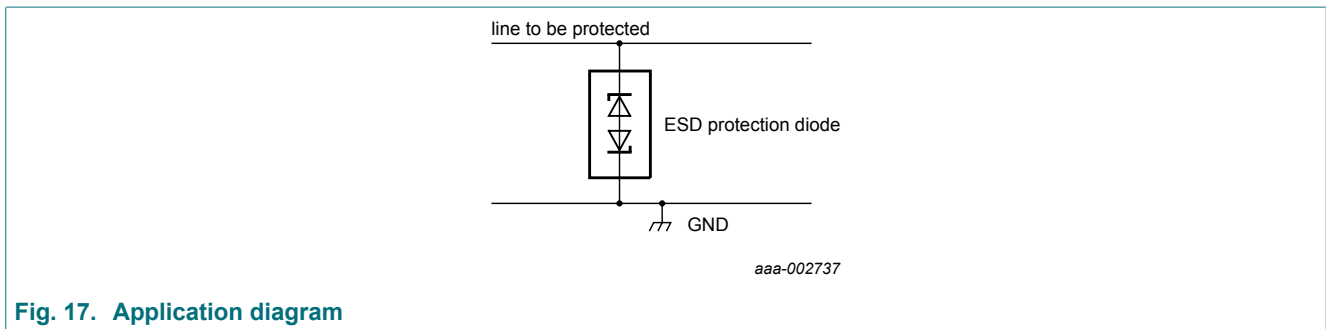


Fig. 17. Application diagram

### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the device as close to the input terminal or connector as possible.
2. Minimize the path length between the device and the protected line.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

### 11. Package outline

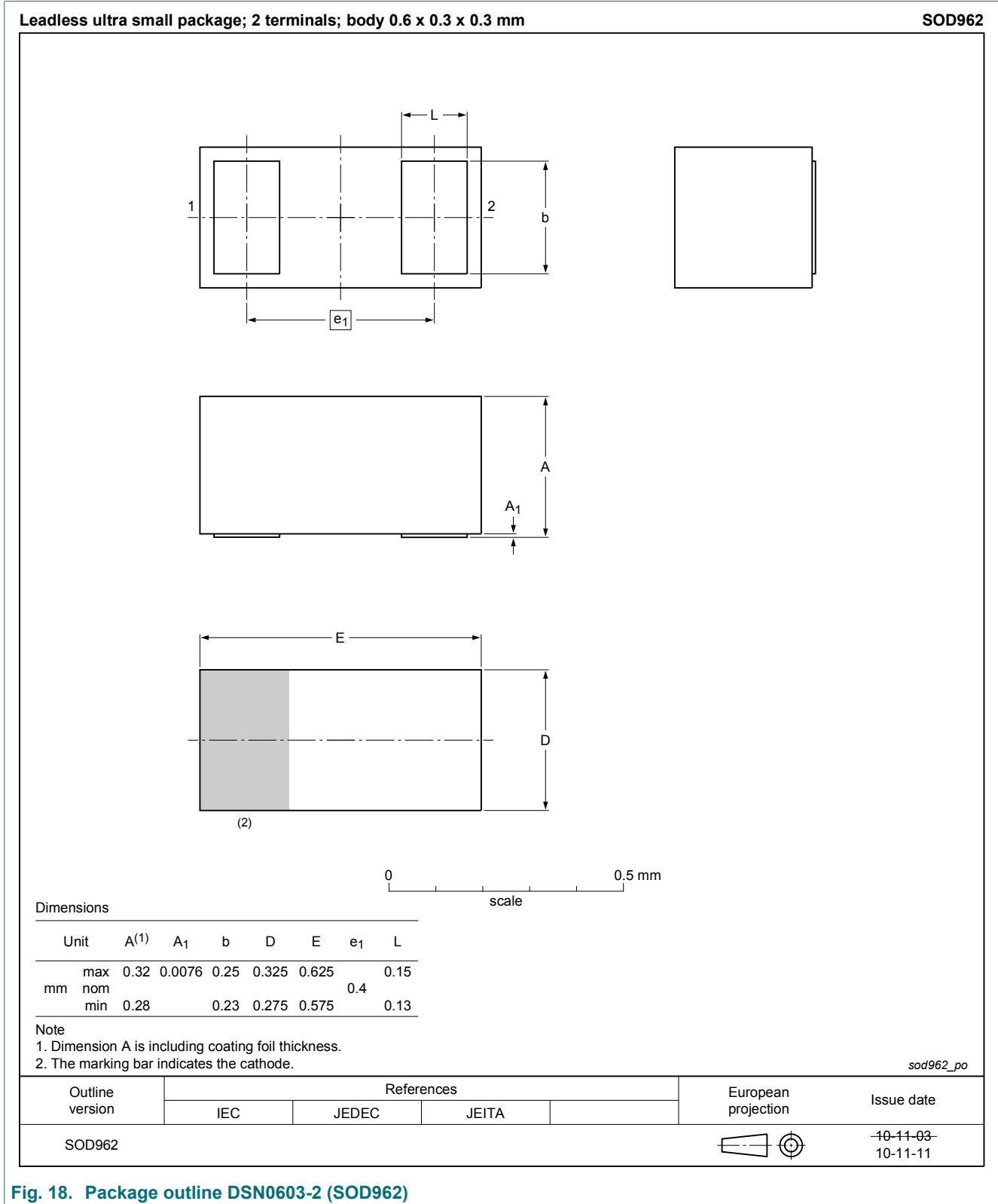
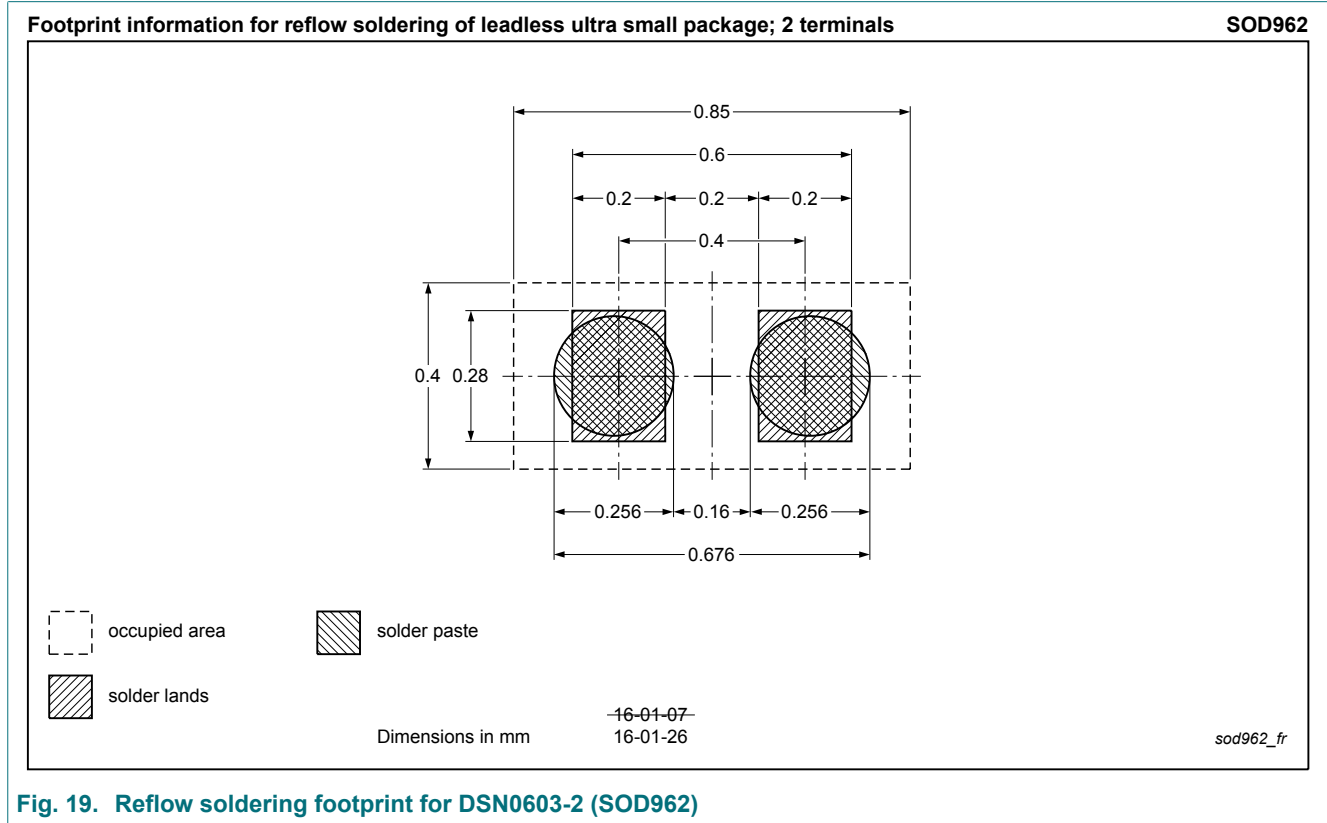


Fig. 18. Package outline DSN0603-2 (SOD962)

## 12. Soldering



## 13. Revision history

Table 7. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PESD3V3Y1BSF v.1	20180607	Product data sheet	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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**Extremely low capacitance bidirectional ESD protection diode**

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